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(54) POLYIMIDE SOLUTION EXCELLENT IN STORAGE STABILITY, POLYIMIDE-BASED ADHESIVE SOLUTION AND FILM-LIKE LAMINATED MEMBER OBTAINED USING THE SAME

(57)Abstract:

PROBLEM TO BE SOLVED: To provide a polyimide solution excellent in storage stability useful in the fields such as flexible printed circuit boards, tapes for TAB(tape automated bonding), composite lead frames, laminated materials and the like, where heat resistance and adhesion properties are required, a polyimide-based adhesive solution excellent in heat resistance and adhesion properties, and a film-like laminated member obtained using the same.

SOLUTION: The polyimide solution having storage stability excellent enough to be stored for at least one month at room temperature is obtained by controlling imidization ratio to at least 90% in the soluble thermoplastic polyimide resin solution. Likewise, in the polyimide-based adhesive solution obtained by compounding a thermosetting resin and a curing agent, a high adhesive force can be maintained after a long-term storage.

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